



PCB Number: PMP10783
 PCB Rev: A

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Number: PMP10783	Rev: A	Designed for: Public Release	Mod. Date: 11/7/2014
SVN Rev. Version control disabled		Project Title: 15V/1A ACDC Buck using UCC28C42	
Drawn By: Sheng-Yang Yu		Sheet Title: 90.277Vac to 400V/25mA and 5V/1A	
Engineer: Sheng-Yang Yu		Assembly Variant: 001	Sheet: 1 of 2
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